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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:  
Tsai, et al.

Serial No.: 09/961,134

Filed: September 21, 2001

Confirmation No.: 4110

For: Method and Apparatus for  
Forming Metal Layers

Assistant Commissioner for  
Patents  
Washington, D.C. 20231

Dear Sir:

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Group Art Unit: 1741

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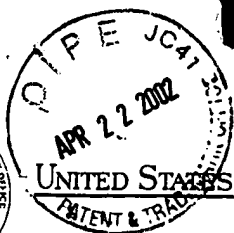
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P.O. Box 450A  
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Respectfully submitted,

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APPLICATION NUMBER	FILING DATE	GRP ART UNIT	FIL FEE REC'D	ATTY. DOCKET NO.	DRAWINGS	TOT CLAIMS	IND CLAIMS
09/961,134 ✓	09/21/2001 ✓	1741 ✓	710 ✓	5262/CMP/CMP/RKK ✓	6 ✓	8 ✓	1 ✓

CONFIRMATION NO. 4110 ✓

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Applicant(s)

✓ Stan Tsai, Fremont, CA; ✓  
✓ Shijian Li, San Jose, CA; ✓

Assignment For Published Patent Application

Applied Materials, Inc.; ✓

Domestic Priority data as claimed by applicant

Foreign Applications

If Required, Foreign Filing License Granted 10/23/2001

Projected Publication Date: 03/27/2003

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Early Publication Request: No

Title

Method and apparatus for forming metal layers ✓

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